

***RoHS Compliant***

# **SATA-Disk Module 4**

***SDM4-M 22P/180D Product Specifications***

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***Version 1.4***



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## Features:

- **Standard Serial ATA 2.6 (Gen. 2)**
  - SATA II, 3.0 Gbps
  - ATA-compatible command set
- **Capacities**
  - 4, 8, 16, 32, 64, 128 GB
- **Performance\***
  - Burst read/write: 300 MB/sec
  - Sustained read: up to 155 MB/sec
  - Sustained write: up to 80 MB/sec
- **Intelligent endurance design**
  - Built-in hardware ECC, enabling up to 16/24 bit correction per 1K bytes
  - Static wear-leveling scheme together with dynamical block allocation to significantly increase the lifespan of a flash device and optimize the disk performance
  - Flash bad-block management
  - S.M.A.R.T.
  - Power Failure Management
  - ATA Secure Erase
  - TRIM
- **NAND Flash Type: MLC**
- **Temperature ranges**
  - Operation: 0°C to 70°C
  - Extended: -40°C ~ +85°C\*\*
  - Storage: -40°C to 100°C
- **Supply voltage**
  - 5.0 V  $\pm$  5%
- **Power consumption (typical)\***
  - Active mode: 310 mA@5.0 V
  - Idle mode: 86 mA@5.0 V
- **Connector type**
  - 7-pin SATA signal connector
  - 15-pin SATA power connector
- **Form factor**
  - SATA Disk Module
- **Shock & Vibration\*\*\***
  - Shock: 1500 G
  - Vibration: 15 G
- **RoHS compliant**

\*Varies from capacities. The values for performances and power consumptions presented are typical and may vary depending on flash configurations or platform settings. The term idle refers to the standby state of the device.

\*\*Only available in 8, 16, 32 & 64GB capacities. For details, please see "Product Ordering Information".

\*\*\*Non-operating

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## 1. General Description

Apacer's SATA-Disk Module 4 (SDM4) is a high-performance, embedded SSD designed to replace the conventional SATA hard disk drive. SDM SSD can be plugged into a standard Serial ATA connectors commonly found in desktops, IT-STB, industrial PC and thin client systems. Moreover, SDM4 provides an innovative way for design-in clients with compact host systems.

Apacer's SDM4 has a built-in microcontroller with file management firmware that communicates with SATA standard interface. This product is well suited for embedded flash storage applications offering new and expanded functionalities as well as more cost-effective designs, better performance and increased reliability.

SDM4 Series is designed to work at 5 Volts and uses a standard SATA driver that complies with major operating systems such as Microsoft's Windows series. Featuring technologies as Apacer-specific Wear-leveling algorithms, S.M.A.R.T, bad block management, Power Failure Management, ATA Secure Erase, and TRIM, Apacer assures users of a versatile device on data storage.

This SDM4-M SSD is designed to be rugged for industrial applications where harsh, demanding environments are often encountered, and has gone through environmental testings such as shock, wide temperature range and ESD. Our SSDs meet international standards and we specialized in customization services in both hardware and systems.

Our customization services include:

- Product change notification (PCN)<sup>1</sup>
- Pre-installed software, custom software imaging and ID strings<sup>2</sup>
- Customize packaging and labeling<sup>2</sup>
- Specified testing<sup>2</sup>
- Safety packaging, such as ESD protection pad, honeycomb-cut packing in sponge, or other types of protection.
- Field Application Engineers in our overseas branches for technical support

<sup>1</sup>Usually notified by our sales representatives or product managers, instead of on packages.

<sup>2</sup>Depending on specified requests

### 1.1 Performance-Optimized Controller

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The heart of SDM4-M is the Flash controller, which translates standard SATA signals into the data and controls of the flash media. The SATA and Flash Management controller are specifically designed to attain high data throughput from the host to the flash.

#### 1.1.1 Power Management

The controller comes with SATA physical interface (PHY) that takes a significant part of the total power budget of the host or other connected electronics. SATA interface provides the means to place the PHY into lowered power modes. When the parts of power for PHY are shut down to reserve power supply, the ability of the SATA interfaced device to respond to command can be affected. Thus, the SATA protocol is implemented with the capability to track the power modes of the devices and require the additional latency to wake up PHY from lowered power modes.

#### 1.1.2 RAM

The controller is implemented with RAM as a data buffer to optimize data transfer between the host and the flash media.

## 2. Functional Block Diagram

SDM4-M includes the SATA and Flash Management controllers, and flash media, as well as the SATA standard interface. Figure 2-1 shows the functional block diagram.

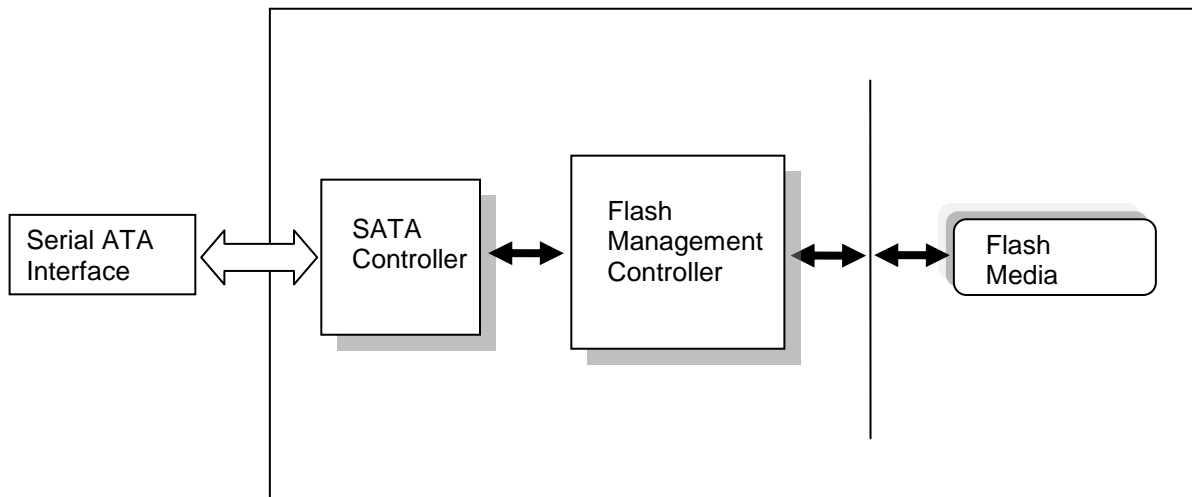


Figure 2-1: Functional block diagram

### 3. Pin Assignments

SATA Connectors

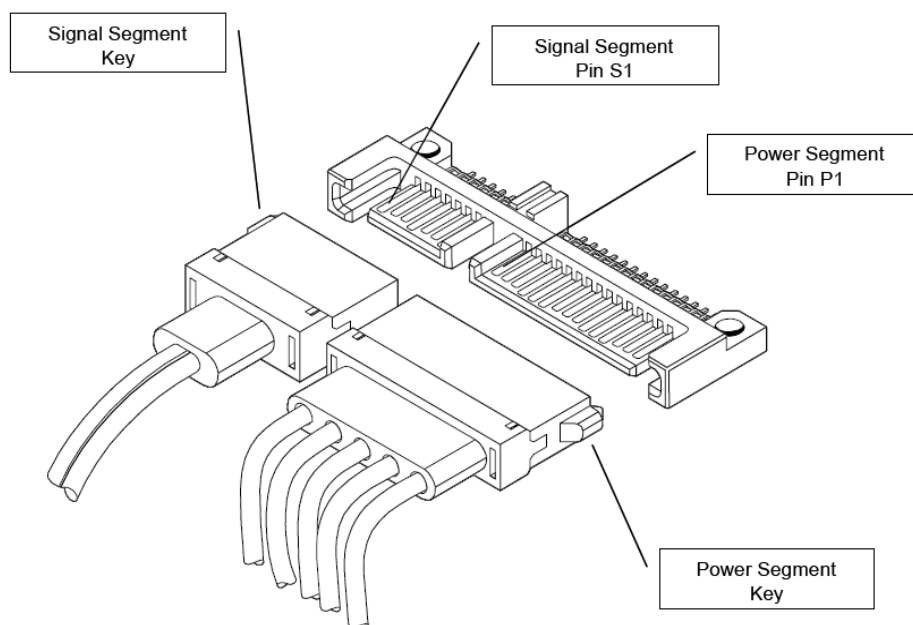
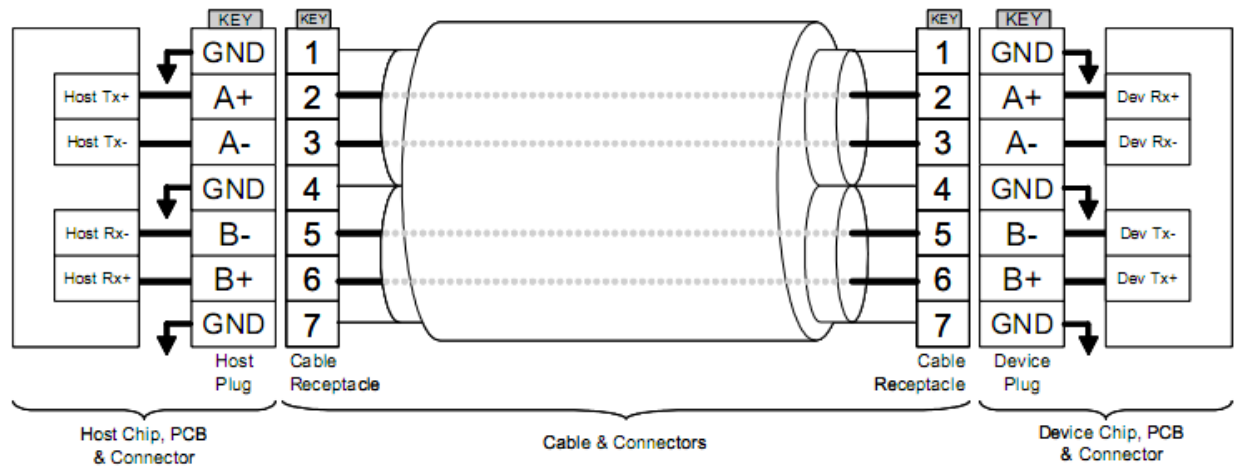


Table 3-1: Signal segment

Name	Type	Description
S1	GND	
S2	RxP	+ Differential Receive Signal
S3	RxN	- Differential Receive Signal
S4	GND	
S5	TxN	- Differential Transmit Signal
S6	TxP	+ Differential Transmit Signal
S7	GND	

Table 3-2: Power segment

Pin	Signal/Description
P1	Unused (3.3V)
P2	Unused (3.3V)
P3	Unused (3.3V)
P4	Ground
P5	Ground
P6	Ground
P7	5V
P8	5V
P9	5V
P10	Ground
P11	Reserved/Ground
P12	Ground
P13	Unused (12V)
P14	Unused (12V)
P15	Unused (12V)



**Figure 3-1** SATA Cable/Connector Connection Diagram

The connector on the left represents the Host with TX/RX differential pairs connected to a cable. The connector on the right shows the Device with TX/RX differential pairs also connected to the cable. Notice also the ground path connecting the shielding of the cable to the Cable Receptacle.

## 4. Product Specifications

### 4.1 Capacity

Capacity specification of SDM4-M is available as shown in Table 4-1. It lists the out-of-box capacity.

**Table 4-1:** Capacity specifications

Capacity	Total bytes*	Cylinders	Heads	Sectors	Max LBA
4 GB	4,011,614,208	7,773	16	63	7,835,184
8 GB	8,012,390,400	15,525	16	63	15,649,200
16 GB	16,013,942,784	16,383	16	63	31,277,232
32 GB	32,017,047,552	16,383	16	63	62,533,296
64 GB	64,023,257,088	16,383	16	63	125,045,424
128 GB	126,718,694,912	16,383	16	63	247,497,451

\*Display of total bytes varies from file systems, which means not all of the bytes can be used for storage.

\*\*Notes: 1 GB = 1,000,000,000 bytes; 1 sector = 512 bytes.

LBA count addressed in the table above indicates total user storage capacity and will remain the same throughout the lifespan of the device. However, the total usable capacity of the SSD is most likely to be less than the total physical capacity because a small portion of the capacity is reserved for device maintenance usages.

### 4.2. ATA Modes Support

- Supports up to PIO Mode-4
- Supports up to Multi-word DMA Mode-2
- Supports up to Ultra DMA Mode-5

### 4.3 Performance

**Table 4-2:** Performance (Standard)

Capacity	4 GB	8 GB	16 GB	32 GB	64 GB
Performance					
Sustained read (MB/s)	65	65	70	80	80
Sustained write (MB/s)	12	12	17	43	43

Performance (High-speed)

Capacity	8 GB	16 GB	32 GB	64 GB	128 GB
Performance					
Sustained read (MB/s)	117	125	135	155	145
Sustained write (MB/s)	26	26	38	80	80

Note: Results may differ from various flash configurations.



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## 4.4 Environmental Specifications

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Environmental specification of SDM4-M product family which follows the MIL-STD-202 and MIL-STD-810 standards is available as shown in Table 4-3.

**Table 4-3** SDM4-M environmental specifications

Item	Specification
Operating temp.	0~70°C (standard); -40 ~ +85°C (extended)
Non-operating temp.	-40~100(°C)
Operating vibration	20~2000(Hz), 7.69 (Grms), random wave, X, Y, Z axis
Non-operating vibration	10~2000(Hz), 15(G), sine wave, X, Y, Z axis
Operating shock	50(G), 11(ms), half-sine wave
Non-operating shock	1500(G), 0.5(ms), half-sine wave

Note: Extended temperature only applies to 8, 16, 32, 64GB of this product family.

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## 4.5 Mean Time Between Failures (MTBF)

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Mean Time Between Failures (MTBF) is predicted based on reliability data for the individual components in SDM4-M. The prediction result for SDM4-M is more than 1,000,000 hours.

Notes about the MTBF:

The MTBF is predicated and calculated based on “Telcordia Technologies Special Report, SR-332, Issue 2” method.

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## 4.6 Certification and Compliance

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SDM4-M complies with the following standards:

- CE
- FCC
- RoHS
- MIL-STD-202 and MIL-STD-810

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## **5. Flash Management**

### **5.1 Error Correction/Detection**

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SDM4-M implements a hardware ECC scheme, based on the BCH algorithm. It can detect and correct up to 16 bits or 24 bits error in 1K bytes.

### **5.2 Bad Block Management**

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Current production technology is unable to guarantee total reliability of NAND flash memory array. When a flash memory device leaves factory, it comes with a minimal number of initial bad blocks during production or out-of-factory as there is no currently known technology that produce flash chips free of bad blocks. In addition, bad blocks may develop during program/erase cycles. When host performs program/erase command on a block, bad block may appear in Status Register. Since bad blocks are inevitable, the solution is to keep them in control. Apacer flash devices are programmed with ECC, block mapping technique and S.M.A.R.T to reduce invalidity or error. Once bad blocks are detected, data in those blocks will be transferred to free blocks and error will be corrected by designated algorithms.

### **5.3 Wear Leveling**

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Flash memory devices differ from Hard Disk Drives (HDDs) in terms of how blocks are utilized. For HDDs, when a change is made to stored data, like erase or update, the controller mechanism on HDDs will perform overwrites on blocks. Unlike HDDs, flash blocks cannot be overwritten and each P/E cycle wears down the lifespan of blocks gradually. Repeatedly program/erase cycles performed on the same memory cells will eventually cause some blocks to age faster than others. This would bring flash storages to their end of service term sooner. Wear leveling is an important mechanism that level out the wearing of blocks so that the wearing-down of blocks can be almost evenly distributed. This will increase the lifespan of SSDs. Commonly used wear leveling types are Static and Dynamic.

### **5.4 Power Failure Management**

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Power Failure Management plays a crucial role when experiencing unstable power supply. Power disruption may occur when users are storing data into the SSD. In this urgent situation, the controller would run multiple write-to-flash cycles to store the metadata for later block rebuilding. This urgent operation requires about several milliseconds to get it done. At the next power up, the firmware will perform a status tracking to retrieve the mapping table and resume previously programmed NAND blocks to check if there is any incompleteness of transmission.

### **5.5 ATA Secure Erase**

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ATA Secure Erase is an ATA disk purging command currently embedded in most of the storage drives. Defined in ATA specifications, (ATA) Secure Erase is part of Security Feature Set that allows storage drives to erase all user data areas. The erase process usually runs on the firmware level as most of the ATA-based storage media currently in the market are built-in with this command. ATA Secure Erase can securely wipe out the user data in the drive and protects it from malicious attack.

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## **5.6 TRIM**

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TRIM, though in capital letters usually, is a memory computation command rather than an abbreviation. It is mainly a SATA command that enables the operating system to inform the SSD (Solid State Drive) which blocks of previously stored data are no longer valid, due to erases by the host or operating system, such as file deletions or disk formatting. Once notified, SSD will begin the discard of the invalid LBAs and retain more space for itself, in fact, the discarded is no longer recoverable.

When an LBA is replaced by the operating system, as with overwrite of a file, the SSD is informed that the originally occupied LBA is determined as no longer in use or invalid. The SSD will not save those blocks in garbage collected sectors. Noticeably, a file deletion command by host or operating system never actually erases the actual content, rather, just the file is marked as deleted. This issue is even specifically noticeable for flash based memory devices, such as SSDs. In fact, an SSD will keep garbage collecting the invalid, previously occupied LBAs, if it is not informed that these LBAs can be erased. Thus, the SSD would experience a significant performance downfall.

## 6. Software Interface

### 6.1 Command Set

**Table 6-1:** Command set

Code	Command	Code	Command
E5h	Check Power Mode	F3h	Security Erase Prepare
06h	Data Set Management	F4h	Security Erase Unit
90h	Execute Device Diagnostic	F5h	Security Freeze Lock
E7h	Flush Cache	F1h	Security Set Password
EAh	Flush Cache EXT	F2h	Security Unlock
ECh	Identify Device	70h	Seek
E3h	Idle	EFh	Set Features
E1h	Idle Immediate	C6h	Set Multiple Mode
91h	Initialize Device Parameters	E6h	Sleep
C8h	Read DMA	B0h	SMART
25h	Read DMA EXT	E2h	Standby
C4h	Read Multiple	E0h	Standby Immediate
29h	Read Multiple EXT	CAh	Write DMA
20h	Read Sector	35h	Write DMA EXT
24h	Read Sector EXT	C5h	Write Multiple
40h	Read Verify Sectors	39h	Write Multiple EXT
42h	Read Verify Sectors EXT	30h	Write Sector
10h	Recalibrate	34h	Write Sector EXT
F6h	Security Disable Password		

### 6.2 S.M.A.R.T.

S.M.A.R.T. is an abbreviation for Self-Monitoring, Analysis and Reporting Technology, a self-monitoring system that provides indicators of drive health as well as potential disk problems. It serves as a warning for users from unscheduled downtime by monitoring and displaying critical drive information. Ideally, this should allow taking proactive actions to prevent drive failure and make use of S.M.A.R.T. information for future product development reference.

Apacer devices use the standard SMART command B0h to read data out from the drive to activate our S.M.A.R.T. feature that complies with the ATA/ATAPI specifications. S.M.A.R.T. Attribute IDs shall include initial bad block count, total later bad block count, maximum erase count, average erase count, power on hours and power cycle. When the S.M.A.R.T. Utility running on the host, it analyzes and reports the disk status to the host before the device reaches in critical condition.

Note: attribute IDs may vary from product models due to various solution design and supporting capabilities.

## 7. Electrical Specification

**Caution: Absolute Maximum Stress Ratings** – Applied conditions greater than those listed under “Absolute Maximum Stress Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these conditions or conditions greater than those defined in the operational sections of this data sheet is not implied. Exposure to absolute maximum stress rating conditions may affect device reliability.

**Table 7-1: Operating range**

Range	Ambient Temperature	5V
Standard	0°C to +70°C	4.75-5.25V
Extended Temperature	-40°C to 85°C	

Note: Extended ambient temperature only applies to 8, 16, 32, 64GB of this product family.

**Table 7-2: Power consumption – Standard (typical)**

Mode \ Capacity	4 GB	8 GB	16 GB	32 GB	64 GB
Active (mA)	175	175	175	210	225
Stand By (mA)	83	88	88	88	88

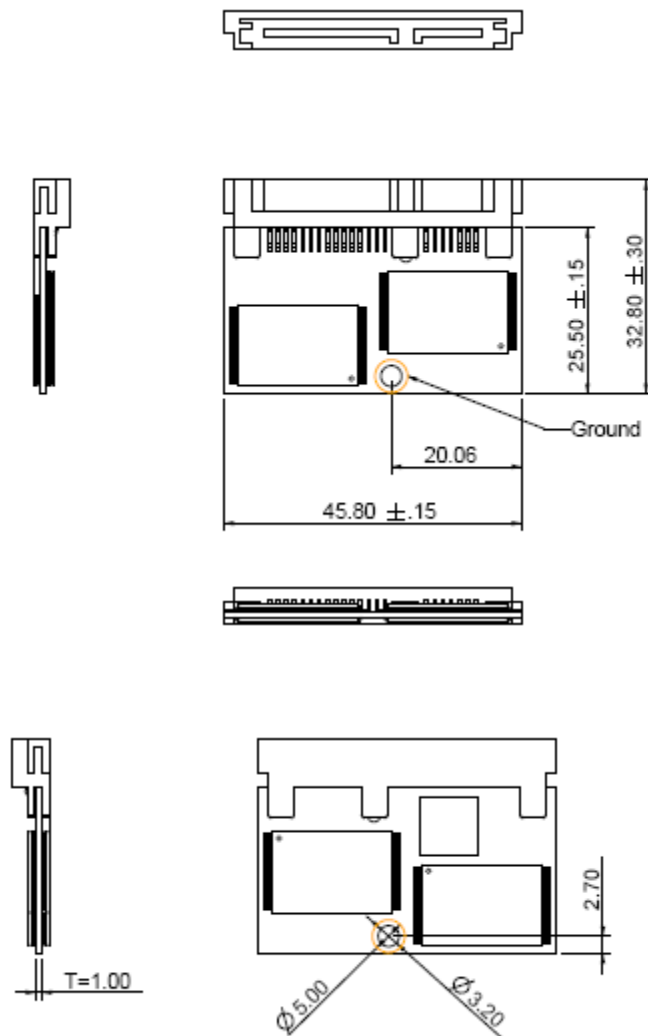
Power consumption – High speed (typical)

Mode \ Capacity	8 GB	16 GB	32 GB	64 GB	128 GB
Active (mA)	200	200	210	280	310
Stand By (mA)	70	76	83	83	86

Note: Power consumptions may vary depending on settings and platforms

## 8. Physical Characteristics

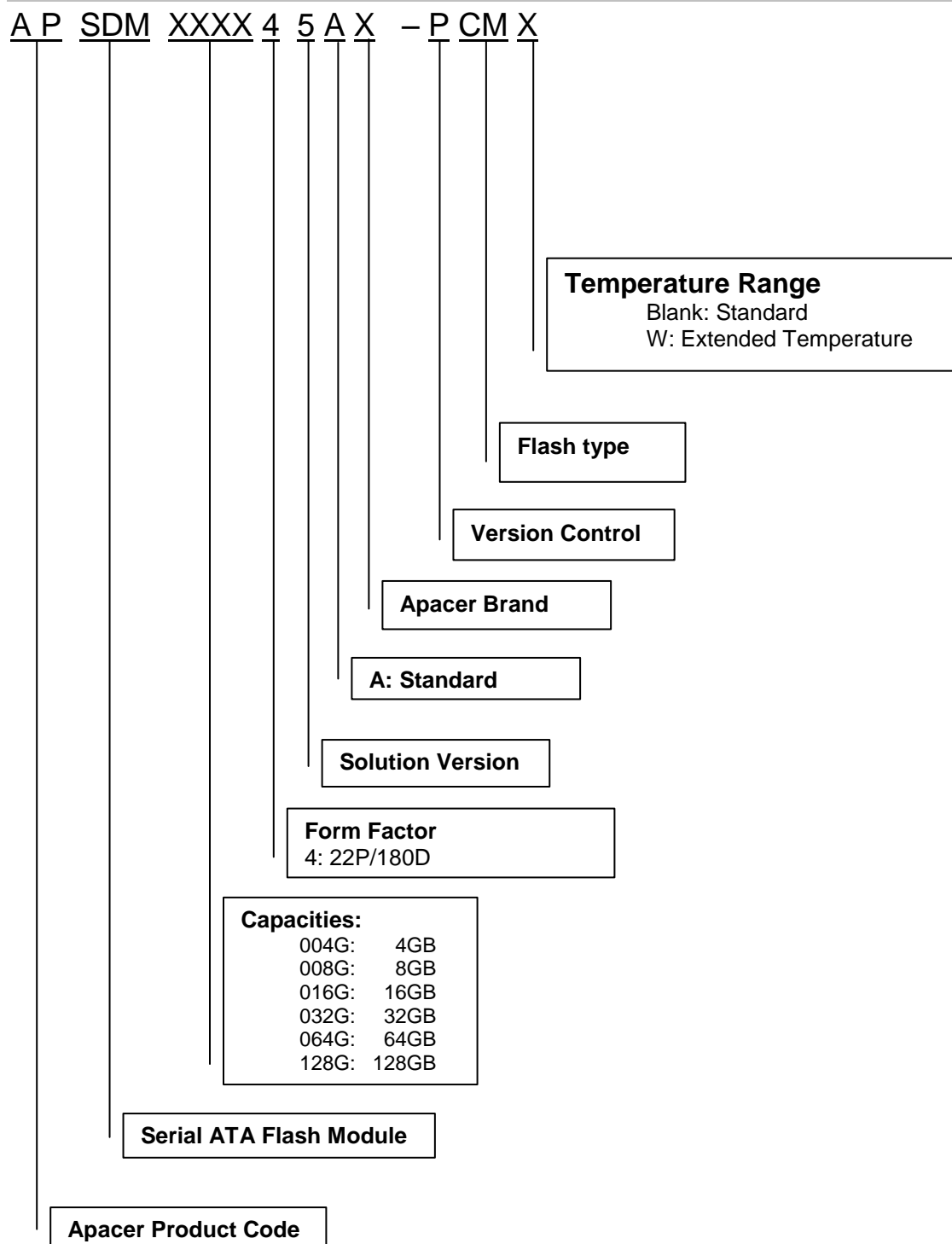
### 8.1 Dimensions



Unit: mm  
Tolerance: +0.25

## 9. Product Ordering Information

### 9.1 Product Code Designations



## 9.2 Valid Combinations

### 9.2.1 SDM4-M 22P/180D standard type

Capacity	Standard	Extended Temperature
4GB	APSDM004G45AN-PCM	--
8GB	APSDM008G45AN-PCM	APSDM008G45AN-PCMW
16GB	APSDM016G45AN-PCM	APSDM016G45AN-PCMW
32GB	APSDM032G45AN-PCM	APSDM032G45AN-PCMW
64GB	APSDM064G45AN-PCM	--

### 9.2.2 SDM4-M 22P/180D high speed type

Capacity	Standard	Extended Temperature
8GB	APSDM008G45AD-PCM	--
16GB	APSDM016G45AD-PCM	APSDM016G45AD-PCMW
32GB	APSDM032G45AD-PCM	APSDM032G45AD-PCMW
64GB	APSDM064G45AD-PCM	APSDM064G45AD-PCMW
128GB	APSDM128G45AD-PCM	--

**Note:** Please consult with Apacer sales representatives for availabilities.



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## Revision History

Revision	Date	Description	Remark
0.1	11/22/2011	Preliminary release	
1.0	11/28/2011	Official release	
1.1	1/20/2012	Revised Capacity Specifications	
1.2	11/16/2012	Updated Product Ordering Information due to firmware upgrade	
1.3	06/20/2013	Updated Product Ordering Information due to firmware upgrade	
1.4	11/25/2014	Revised typo : 9.2.2 SDM4-M 22P/90D high speed type->22P/180	

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## Global Presence

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